

## CSFM101-G Thru. CSFM105-G

**Reverse Voltage: 50 to 600 Volts**

**Forward Current: 1.0 Amp**

**RoHS Device**

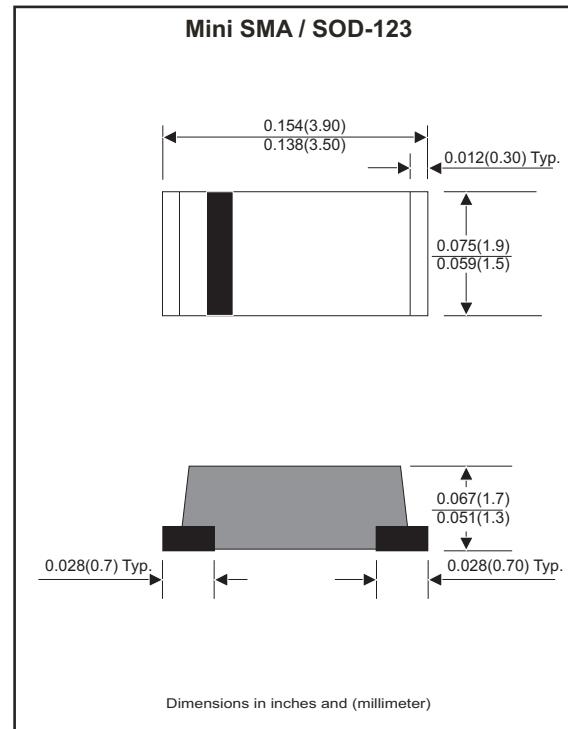


### Features

- Batch process design, excellent power dissipation offers better reverse leakage current and thermal resistance.
- Low profile surface mounted application in order to optimize board space.
- Tiny plastic SMD package.
- Super fast recovery time for switching mode application.
- High current capability.
- High surge current capability.
- Glass passivated chip junction.

### Mechanical data

- Epoxy: UL 94-V0 rated flame retardant.
- Case: Molded plastic, JEDEC SOD-123/Mini SMA.
- Terminals: Solderable per MIL-STD-750, method 2026.
- Polarity: Indicated by cathode band.
- Weight: 0.018 grams approx.



### Maximum Ratings (at TA=25°C unless otherwise noted)

Parameter	Conditions	Symbol	CSFM 101-G	CSFM 102-G	CSFM 103-G	CSFM 104-G	CSFM 105-G	Unit
Repetitive peak reverse voltage		V <sub>RRM</sub>	50	100	200	400	600	V
Continuous reverse voltage		V <sub>DC</sub>	50	100	200	400	600	V
RMS voltage		V <sub>RMS</sub>	35	70	140	280	420	V
Max. forward rectified current	Ambient temperature=50°C	I <sub>o</sub>			1.0			A
Maximum Instantaneous forward voltage at I <sub>f</sub> =1.0A		V <sub>F</sub>			0.95	1.25	1.70	V
Forward surge current	8.3ms single half sine-wave superimposed on rated load (JEDEC method)	I <sub>FSM</sub>			25			A
Max. Reverse recovery time	I <sub>F</sub> =0.5A , I <sub>R</sub> =1.0A I <sub>RR</sub> =0.25A	T <sub>rr</sub>			35			nS
Max.Reverse current	V <sub>R</sub> =V <sub>RRM</sub> TJ=@25°C V <sub>R</sub> =V <sub>RRM</sub> TJ=@100°C	I <sub>R</sub>			5.0 100			µA
Typ. Thermal resistance	Junction to ambient	R <sub>θJA</sub>			42			°C/W
Diode junction capacitance	f=1MHz and applied 4V DC reverse voltage	C <sub>J</sub>			10			pF
Operating junction temperature		T <sub>J</sub>			-55 to +150			°C
Storage temperature range		T <sub>STG</sub>			-65 to +175			°C

# SMD Super Fast Recovery Rectifiers

**Comchip**  
SMD Diode Specialist

## Rating and Characteristic Curves (CSFM101-G Thru. CSFM105-G)

Fig.1 - Typical Forward Characteristics

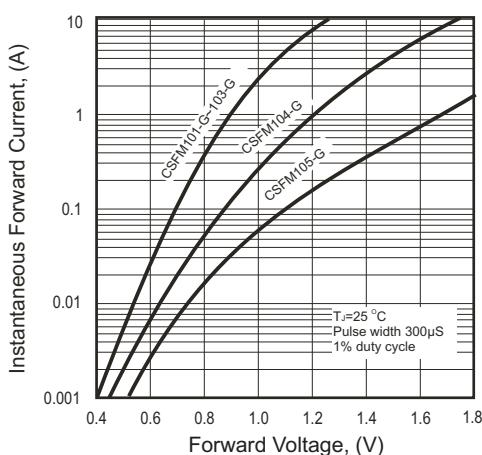


Fig.2 - Typical Forward Current Derating Curve

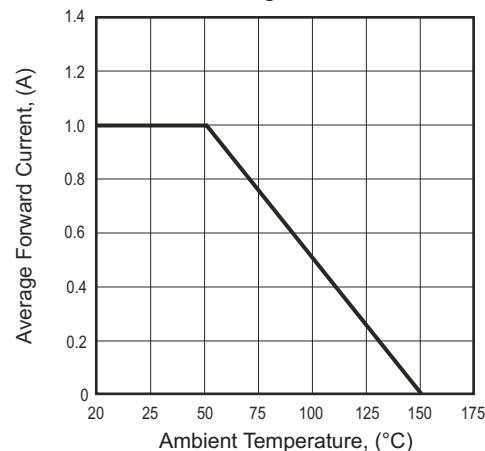


Fig.3 - Test Circuit Diagram and Reverse Recovery Recovery Time Characteristics

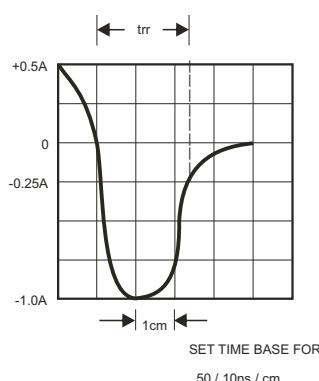
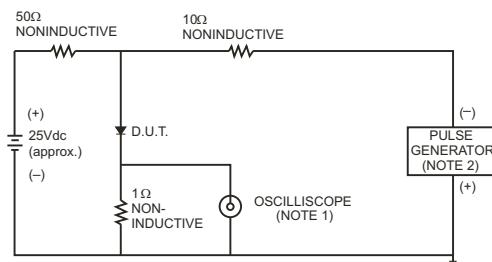


Fig.4 - Non-repetitive Forward Surge Current

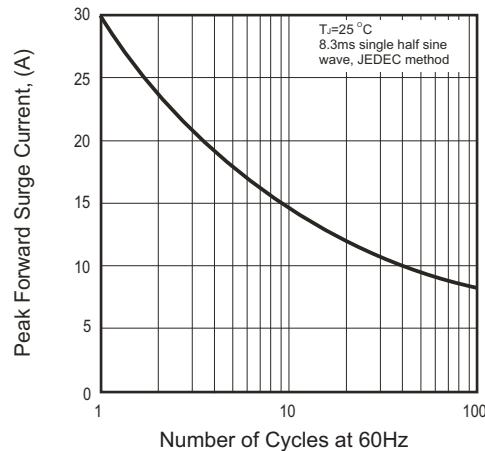
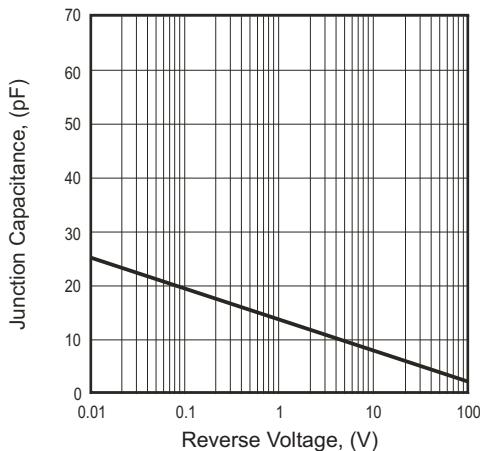
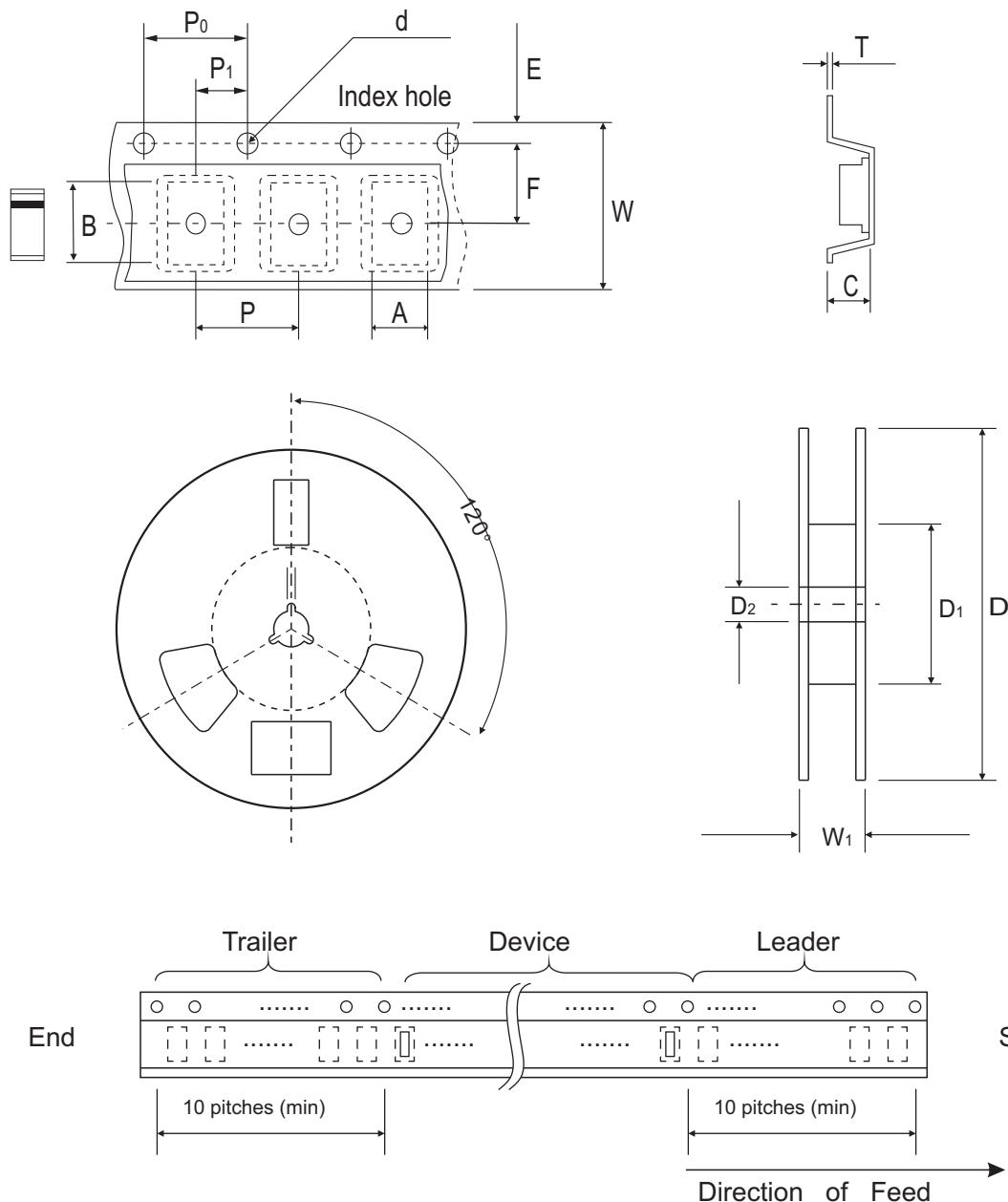


Fig.5 - Typical Junction Capacitance



## Reel Taping Specification



Mini-SMA/SOD-123	SYMBOL	A	B	C	d	D	D1	D2
	(mm)	$1.90 \pm 0.10$	$3.90 \pm 0.10$	$1.68 \pm 0.10$	$1.50 \pm 0.10$	$178 \pm 2.00$	62.0 MIN.	$13.0 \pm 0.50$
	(inch)	$0.075 \pm 0.04$	$0.154 \pm 0.04$	$0.066 \pm 0.04$	$0.059 \pm 0.004$	$7.00 \pm 0.079$	2.440 MIN.	$0.512 \pm 0.020$

Mini-SMA/SOD-123	SYMBOL	E	F	P	P0	P1	T	W	W1
	(mm)	$1.75 \pm 0.10$	$3.50 \pm 0.10$	$4.00 \pm 0.10$	$4.00 \pm 0.10$	$2.00 \pm 0.10$	$0.23 \pm 0.10$	$8.00 \pm 0.30$	$11.40 \pm 1.0$
	(inch)	$0.069 \pm 0.004$	$0.138 \pm 0.004$	$0.157 \pm 0.004$	$0.157 \pm 0.004$	$0.079 \pm 0.004$	$0.009 \pm 0.004$	$0.315 \pm 0.012$	$0.449 \pm 0.004$

## Marking Code

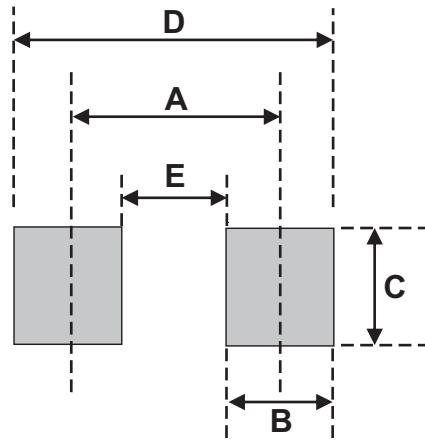
Part Number	Marking Code
CSFM101-G	S1
CSFM102-G	S2
CSFM103-G	S3
CSFM104-G	S6
CSFM105-G	S8



XX = Product type marking code

## Suggested PAD Layout

SIZE	Mini-SMA/SOD-123	
	(mm)	(inch)
A	3.30	0.130
B	1.40	0.055
C	1.90	0.075
D	4.70	0.185
E	1.90	0.075



## Standard Packaging

Case Type	Qty per Reel	Reel Size
	(Pcs)	(inch)
Mini-SMA/SOD-123	2500	7